

# HUBERT KIM

MECHATRONICS ENGINEER

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## SKILLS & TOOLS

### Hardwares, Electronics

- PLC
- ARM Processor

### Data Analysis

- MATLAB
- Python

### Robot Programming

- RAPID - RobotStudio
- RobotDK

### Camera/Image Processing

- OpenCV

## EDUCATION

### PhD,

Mechanical Engineering  
Virginia Tech, Blacksburg, VA  
Earned in Dec 2021

: ICTAS Doctoral Scholarship

### BS, cum laude,

Mechanical Engineering  
NYU Tandon, Brooklyn, NY  
Earned in May 2015

: Best Mechanical Engineering  
Experience Award for  
Undergraduate

April 2015

## SUMMARY

A method developer for 1) improving precision for automation recipe through error boundary control and 2) increasing operational safety margin by implementing evaluation methods for early product development.

## PROFESSIONAL EXPERIENCE

### SYSTEM ENGINEER

Aug 2022 – Current

Mechanical Components and Systems Lab | GE Aerospace Research Center

#### AUTOMATING MANUFACTURE PROCESS

- Developing 2D camera-based Calibration method for precision (accuracy and resolution)
- Controlled error boundary from the optical system (2.5 mil) to increase the ABB robot's factory resolution

#### INSPECTION SERVICE ROBOT, A LIMITED ACCESSABILITY

- Developing evaluation methods for early technology surveillance robot to solve the accessibility issue
- Increased Operational Safety Margin by evaluating various Minimal Viable Prototypes

### GRADUATE RESEARCH ASSISTANT

May 2015 – Dec 2021

Assistive Robotics Laboratory | Virginia Tech

#### WEARABLE ROBOT FOR MOTION TRAINING

- Proposed a new approach to analyze how wearable robots drive the wearers' arms, leading to publications in [Scientific Reports](#) and [IEEE Access](#)
- Developed a lightweight (500 g), cheap (\$ 509), and low-profile exoskeleton as exhibited in [HardwareX](#)

### UNDERGRADUATE RESEARCH ASSISTANT

May 2013 – Dec 2015

Dynamic System Laboratory | NYU

#### MODELING SMART MATERIALS

- Conducted impedance matching with inductor and resistors, to improve the power delivery by more than 60 % , as described in [Smart Materials and Structures](#)
- Carried out signal processing (system identification and impedance analysis) to find the surface resistance's effect, as represented in [J. of Intell Mater Syst Struct](#)